

**General Description**

It's mainly suitable for use as a load switch in battery powered applications.

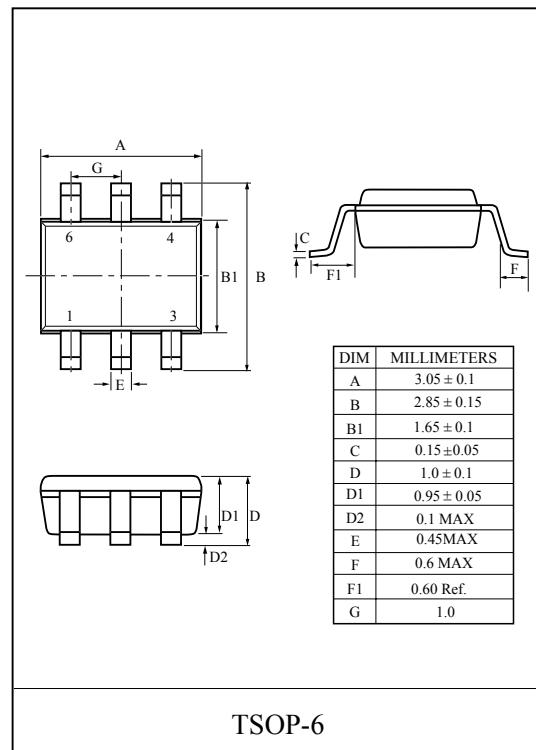
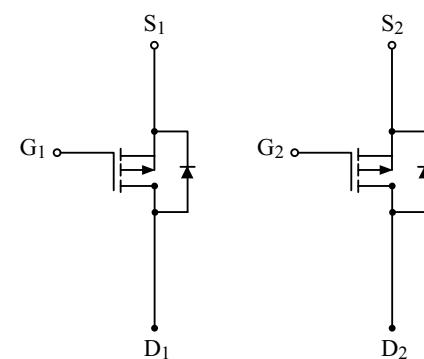
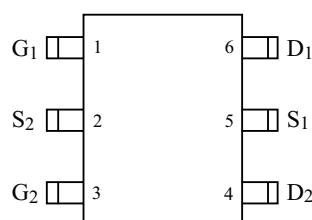
**FEATURES**

- $V_{DSS} = -20V$ ,  $I_D = -2.7A$ .
- Drain-Source ON Resistance.  
:  $R_{DS(ON)} = 100m\Omega$  (Max.) @  $V_{GS} = -4.5V$ .
- $R_{DS(ON)} = 175m\Omega$  (Max.) @  $V_{GS} = -2.5V$ .

**MAXIMUM RATING (Ta=25 °C)**

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		$V_{DSS}$	-20	V
Gate-Source Voltage		$V_{GSS}$	$\pm 12$	V
Drain Current	DC	$I_D$ *	-2.7	A
	Pulsed	$I_{DP}$ *	-8	
Drain Power Dissipation	Ta=25 °C	$P_D$ *	2.1	W
	Ta=100 °C		0.85	
Maximum Junction Temperature		$T_j$	150	°C
Storage Temperature Range		$T_{stg}$	-55~150	°C
Thermal Resistance, Junction to Ambient		$R_{thJA}$ *	59	°C/W

\* : Surface Mounted on 1" × 1" Board,  $t \leq 300/\mu\text{sec}$ .

**PIN CONNECTION (TOP VIEW)**

# KMA2D7DP20X

## ELECTRICAL CHARACTERISTICS (Ta=25°C)

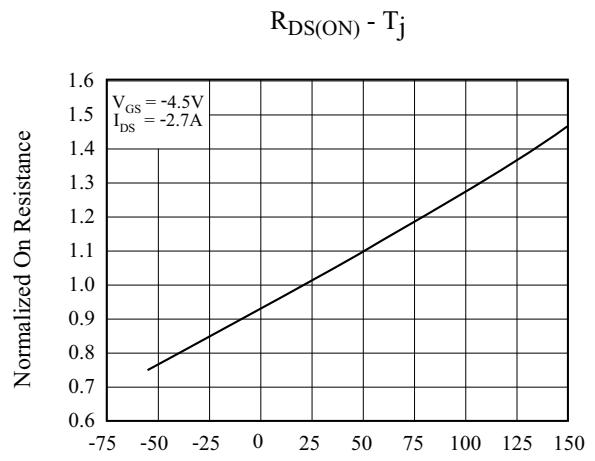
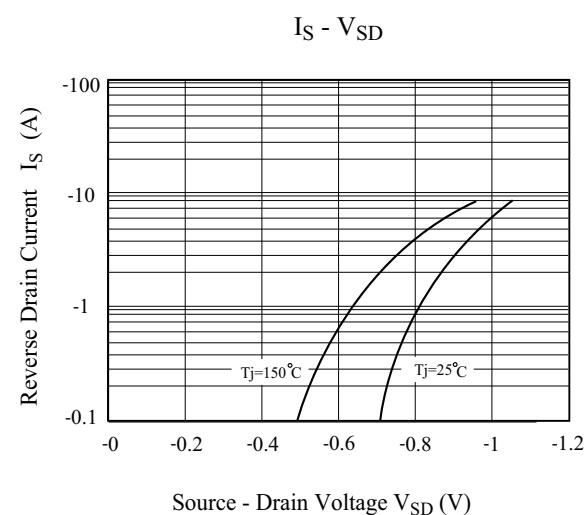
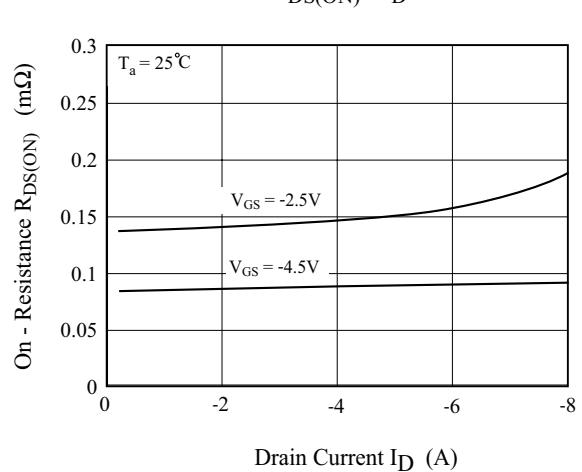
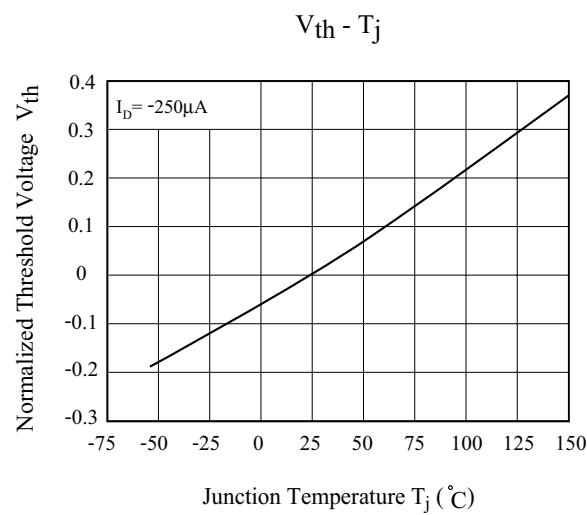
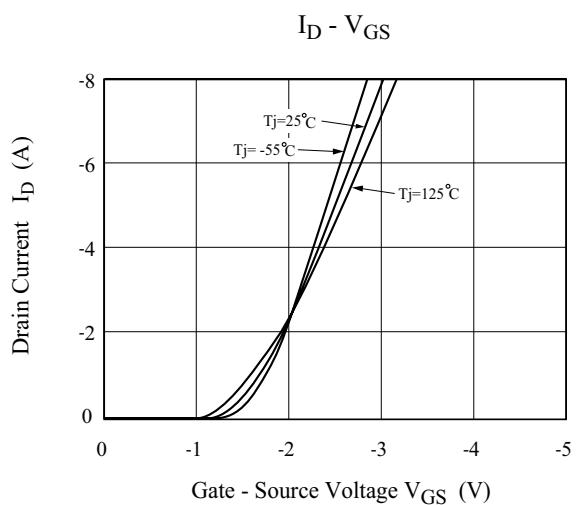
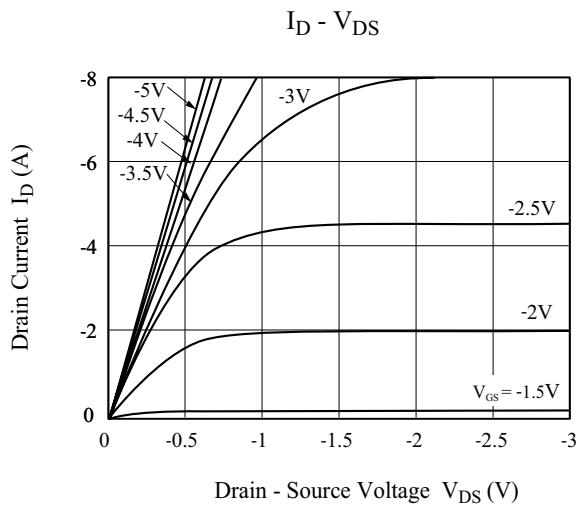
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =-250 μA, V <sub>GS</sub> =0V	-20	-	-	V
Drain Cut-off Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V	-	-	-1	μA
		V <sub>DS</sub> =-16V, V <sub>GS</sub> =0V, T <sub>j</sub> =70 °C (Note 3)	-	-	-5	
Gate Threshold Voltage	V <sub>th</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250 μA	-0.6	-	-	V
Gate Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V	-	-	±100	nA
Drain-Source ON Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2.7A (Note 2)	-	80	100	m Ω
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2.0A (Note 2)	-	140	175	
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>GS</sub> =-4.5V, V <sub>DS</sub> =-5V (Note 2)	-8	-	-	A
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-2.7A (Note 2)	-	4	-	S
<b>Dynamic</b> (Note 3)						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-10V, R <sub>L</sub> =3.7 Ω V <sub>GS</sub> =-4.5V (Fig.1)	-	5.9	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	1	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	2	-	
Turn-on Delay time	t <sub>d(on)</sub>	V <sub>DS</sub> =-10V, R <sub>L</sub> =3.7 Ω V <sub>GS</sub> =-4.5V R <sub>G</sub> =6 Ω (Fig.2)	-	22	-	ns
Turn-on Rise time	t <sub>r</sub>		-	10	-	
Turn-off Delay time	t <sub>d(off)</sub>		-	20	-	
Turn-off Fall time	t <sub>f</sub>		-	40	-	
<b>Source-Drain Diode Ratings</b>						
Continuous Source Current	I <sub>S</sub>	V <sub>GS</sub> < V <sub>th</sub> (Note 1)	-	-	-0.6	A
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-2.7A, V <sub>GS</sub> =0V (Note 2)	-	-	-1.3	V

Note 1) Based on thermal dissipation from junction to ambient while mounted on a 1" × 1" PCB Board.

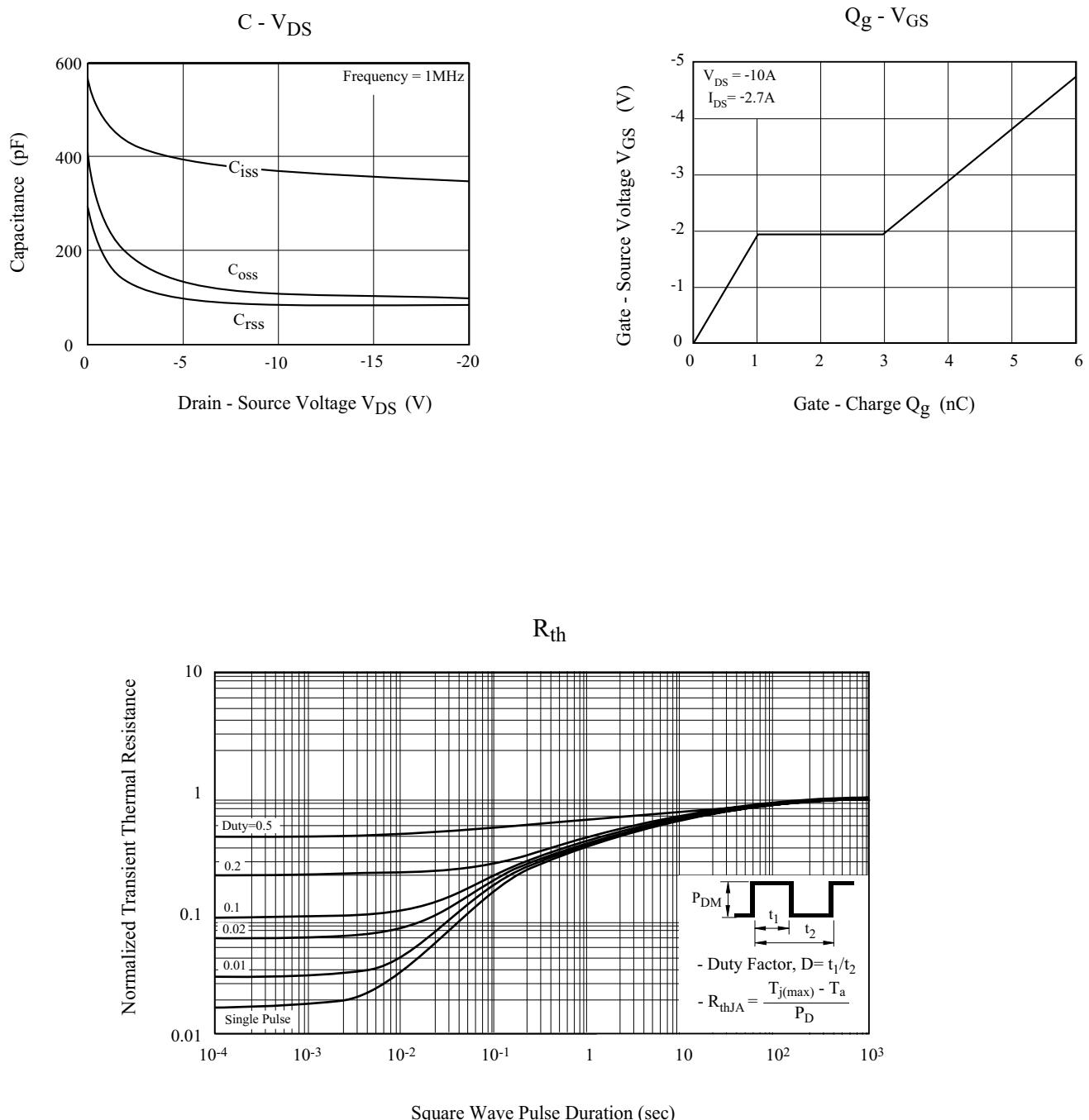
Note 2) Pulse test : Pulse width ≤300 μs.

Note 3) Guaranteed by design, not subject to production testing.

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Fig. 1 Gate Charge

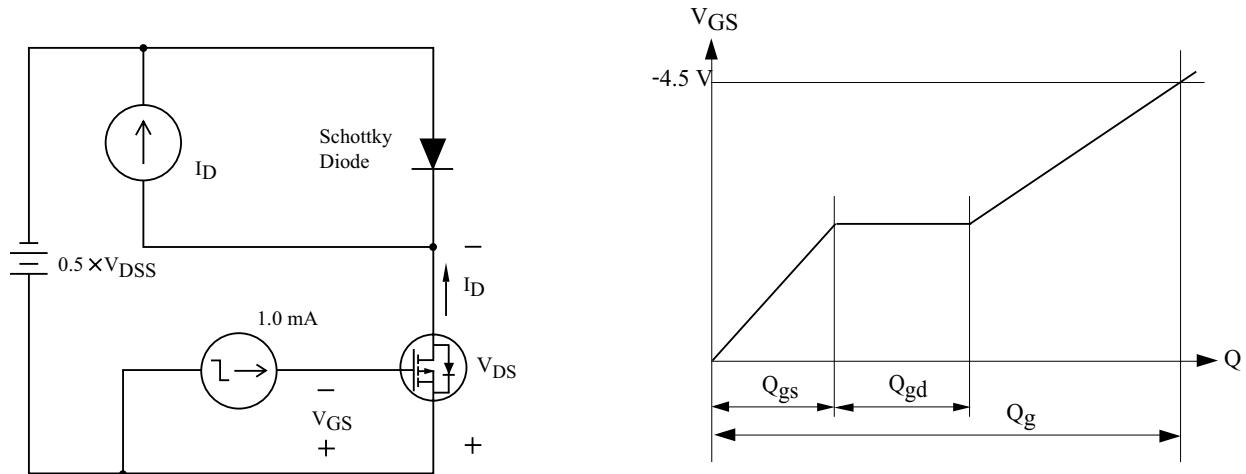


Fig. 2 Resistive Load Switching

